

# AAAF3529LSEKJ3ZGKQBS

3.5 x 2.8 mm Surface Mount SMD Chip LED



#### **DESCRIPTIONS**

- The Hyper Red device is based on light emitting diode chip made from AlGaInP
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- The Blue source color devices are made with InGaN Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

### **FEATURES**

- Outstanding material efficiency
- · Low power consumption
- · Can produce any color in visible spectrum, including
- · Suitable for all SMD assembly and solder process
- · Available on tape and reel
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

### **APPLICATIONS**

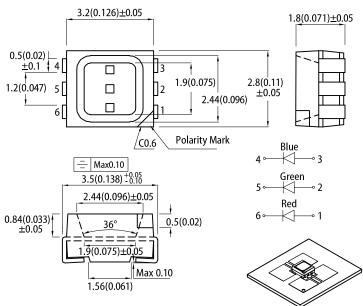
- Backlight
- · Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

### **ATTENTION**

Observe precautions for handling electrostatic discharge sensitive devices

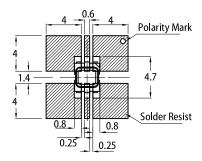


### **PACKAGE DIMENSIONS**



#### RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance:  $\pm$  0.1)



- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.2(0.008") unless otherwise noted.
   The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

  The device has a single mounting surface. The device must be mounted according to the specifications

# **SELECTION GUIDE**

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 2mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
	■ Hyper Red (AlGaInP)		30	60	
AAAF3529LSEKJ3ZGKQBS	■ Green (InGaN)	Water Clear	80	180	130°
	■ Blue (InGaN)		12	30	

Notes.
1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





# ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Symphol	Emitting Color	Va	lue	Unit	
rarameter	Symbol	Emitting Color	Тур.	Max.	Unit	
Wavelength at Peak Emission I <sub>F</sub> = 2mA	$\lambda_{peak}$	Hyper Red Green Blue	640 515 460	-	nm	
Dominant Wavelength I <sub>F</sub> = 2mA	λ <sub>dom</sub> <sup>[1]</sup>	Hyper Red Green Blue	625 525 465	-	nm	
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 2mA	Δλ	Hyper Red Green Blue	20 35 25	-	nm	
Capacitance	С	Hyper Red Green Blue	27 45 100	-	pF	
Forward Voltage I <sub>F</sub> = 2mA	V <sub>F</sub> <sup>[2]</sup> Hyper Red Green Blue		1.8 2.65 2.65	2.1 3.1 3.1	V	
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Hyper Red Green Blue	-	10 50 50	μА	
Temperature Coefficient of $\lambda_{peak}$ $I_F$ = 2mA, -10°C $\leq$ T $\leq$ 85°C	$TC_{\lambda peak}$	Hyper Red Green Blue	0.13 0.05 0.04	-	nm/°C	
Temperature Coefficient of $\lambda_{dom}$ I <sub>F</sub> = 2mA, -10°C $\leq$ T $\leq$ 85°C	$TC_{\lambdadom}$	Hyper Red Green Blue	0.06 0.03 0.03	-	nm/°C	
Temperature Coefficient of $V_F$ $I_F$ = 2mA, -10°C $\leq$ T $\leq$ 85°C	TC <sub>V</sub>	Hyper Red Green Blue	-2.0 -2.9 -2.9	-	mV/°C	

1. The dominant wavelength (\(\lambda\)) above is the setup value of the sorting machine. (Tolerance \(\lambda\text{d}: \pm \) 1. The dominant wavelength \(\lambda\text{d}: \pm \) 1. The dominant wavelength value is traceable to CIE127-2007 standards.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and \(\rangle\) or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

# ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

	Symbol	Value			1114
Parameter		Hyper Red	Green	Blue	Unit
Power Dissipation	P <sub>D</sub>	140	123	120	mW
Reverse Voltage	V <sub>R</sub>	5	5	5	V
Junction Temperature	T <sub>j</sub>	115	115	115	°C
Operating Temperature	T <sub>op</sub>	-40 to +85			°C
Storage Temperature	T <sub>stg</sub>	-40 to +85			°C
DC Forward Current	I <sub>F</sub>	50	30	30	mA
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	150	150	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	250	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	250	390	420	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	120	290	290	°C/W

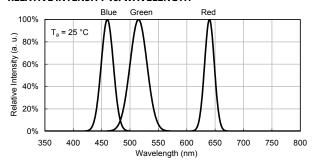
Notes:
1. 1/10 Duty Cycle , 0.1ms Pulse Width .
2. R<sub>n Ja</sub>, R<sub>n Js</sub> Results from mounting on PC board FR4 (pad size≥16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



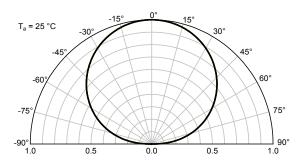


### **TECHNICAL DATA**

#### **RELATIVE INTENSITY vs. WAVELENGTH**

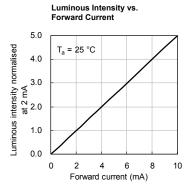


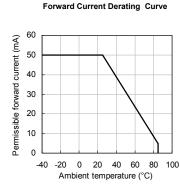
#### **SPATIAL DISTRIBUTION**

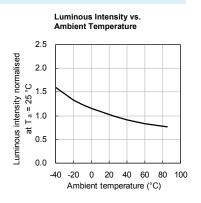


# **HYPER RED**

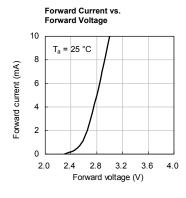
Forward Current vs. Forward Voltage T<sub>a</sub> = 25 °C 8 Forward current (mA) 6 2 0 2.1 2.3 Forward voltage (V)

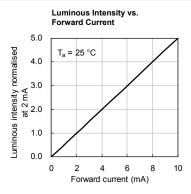


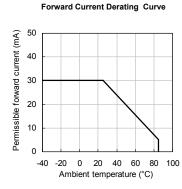


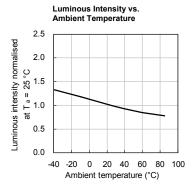


#### **GREEN**



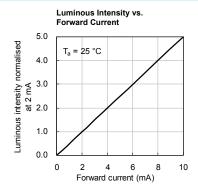


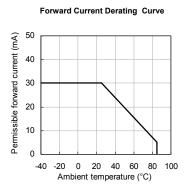


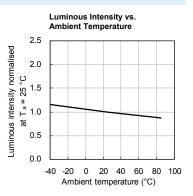


# **BLUE**

Forward Current vs. Forward Voltage 10 T<sub>a</sub> = 25 °C 8 Forward current (mA) 6 4 2 22 24 26 28 3.0 Forward voltage (V)









#### REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

#### above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max 6°C/s max. 200 150 pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 0 0 50 100 150 200 250 300 (sec) Time ---

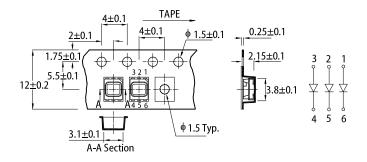
- Notes:

  1. Don't cause stress to the LEDs while it is exposed to high temperature.

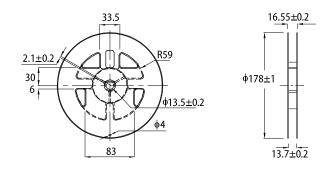
  2. The maximum number of reflow soldering passes is 2 times.

  3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

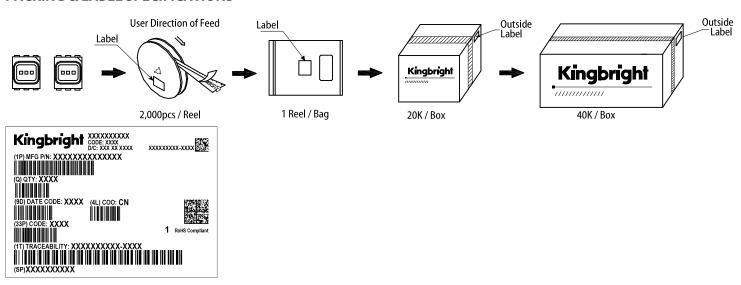
#### TAPE SPECIFICATIONS (units:mm)



#### **REEL DIMENSION** (units: mm)



# **PACKING & LABEL SPECIFICATIONS**





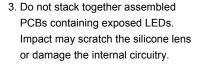
#### HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.

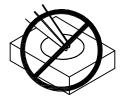


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.











- 4-1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4-2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4-3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.
- As silicone encapsulation is permeable to gases, some corrosive substances such as H<sub>2</sub>S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



#### **PRECAUTIONARY NOTES**

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.

  The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

  The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
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